

Bi2201 **Bi2212**
On the roles of $\text{Bi}_2\text{Sr}_2\text{CuO}_x$ in $\text{Bi}_2\text{Sr}_2\text{CaCu}_2\text{O}_x/\text{Ag}$
round wire transport
on multiple length scales

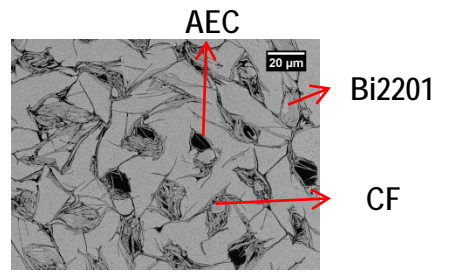
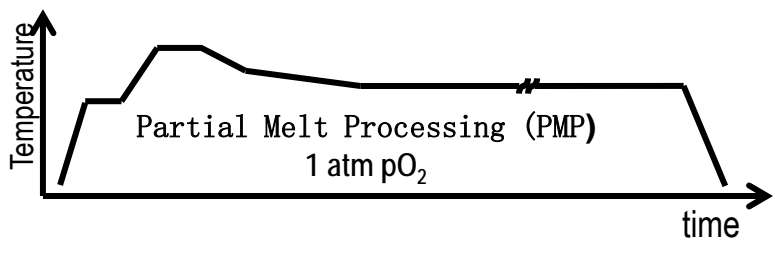
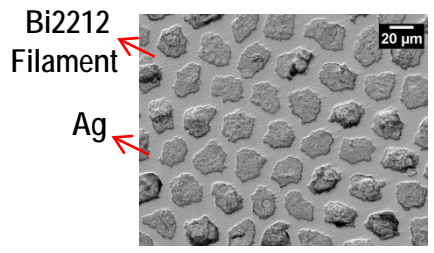
ASC 2014 Best Student Paper Contest

Golsa Naderi, Evan Benjamin Callaway, and Justin Schwartz

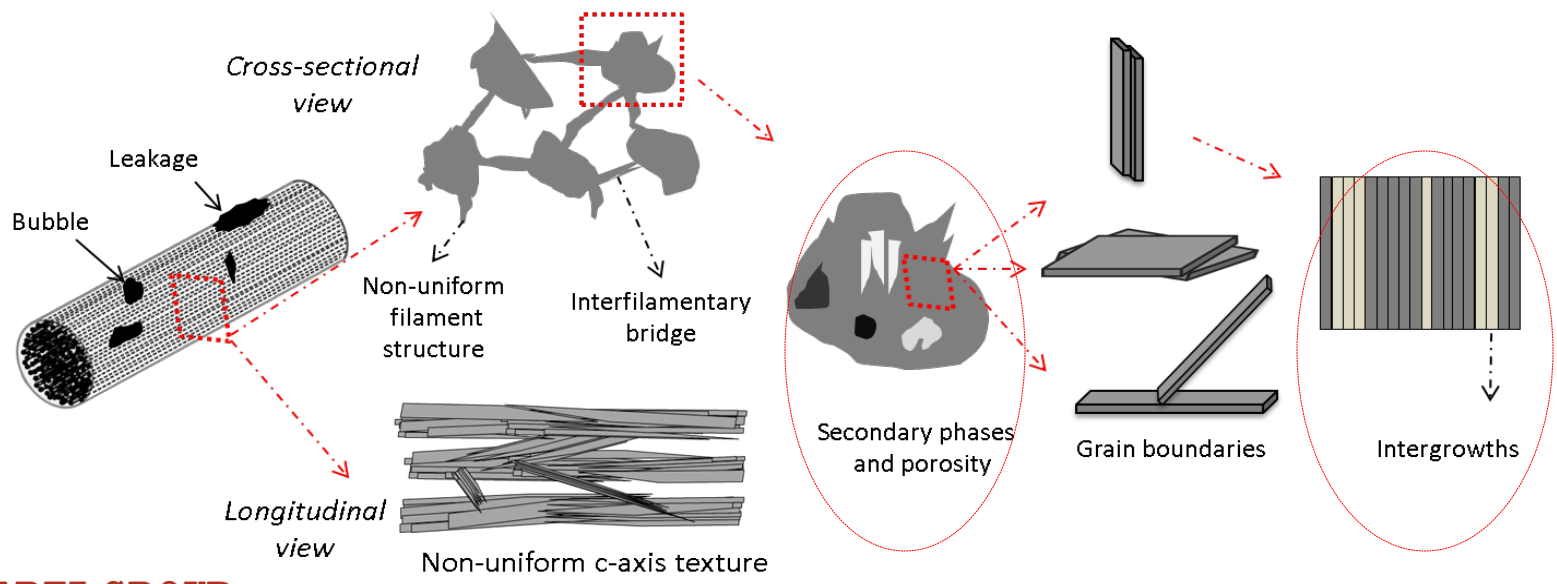
Outline

- Introduction on Bi2212 underlying challenges
- Results and discussions
 - Relationships between transport and filament microstructure
 - Roles of Bi2201 grains
 - Roles of Bi2201 intergrowths
 - Multiscale Bi2201 in over-pressured round wires
- Conclusions

Bi2212 challenges after processing on multiple length scales

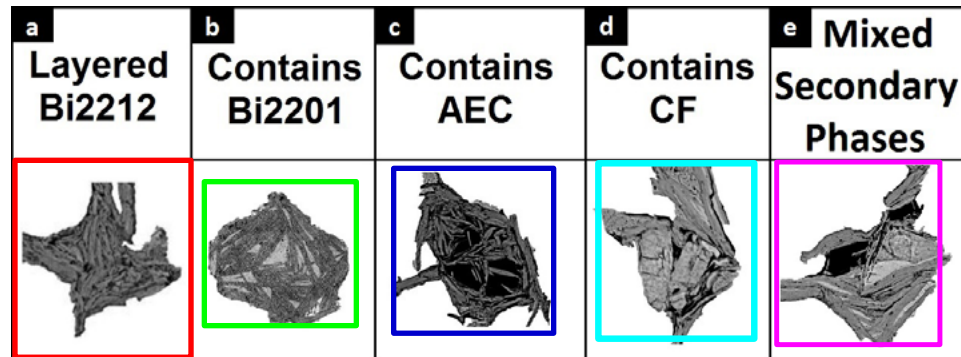


Multifilamentary wire Filament bundle Individual filament Grain colonies Individual grain

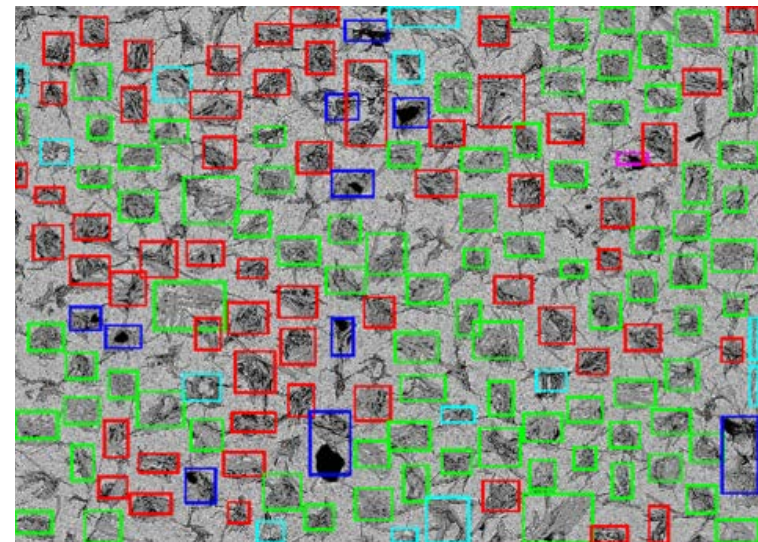
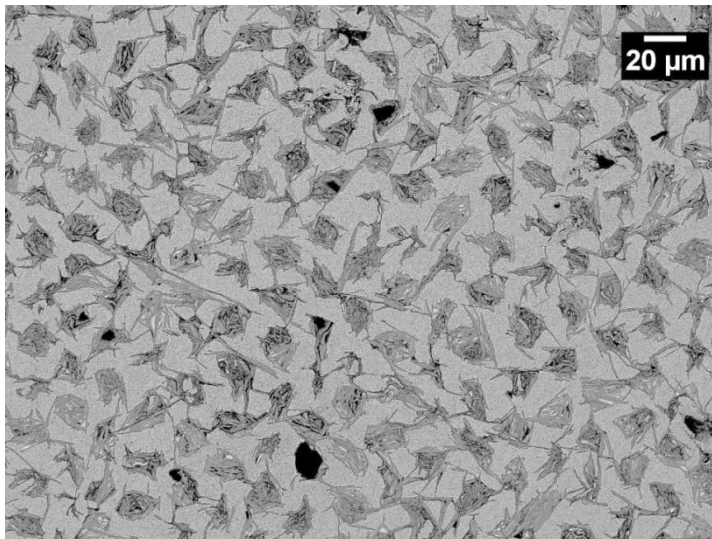


Impurities in individual filaments

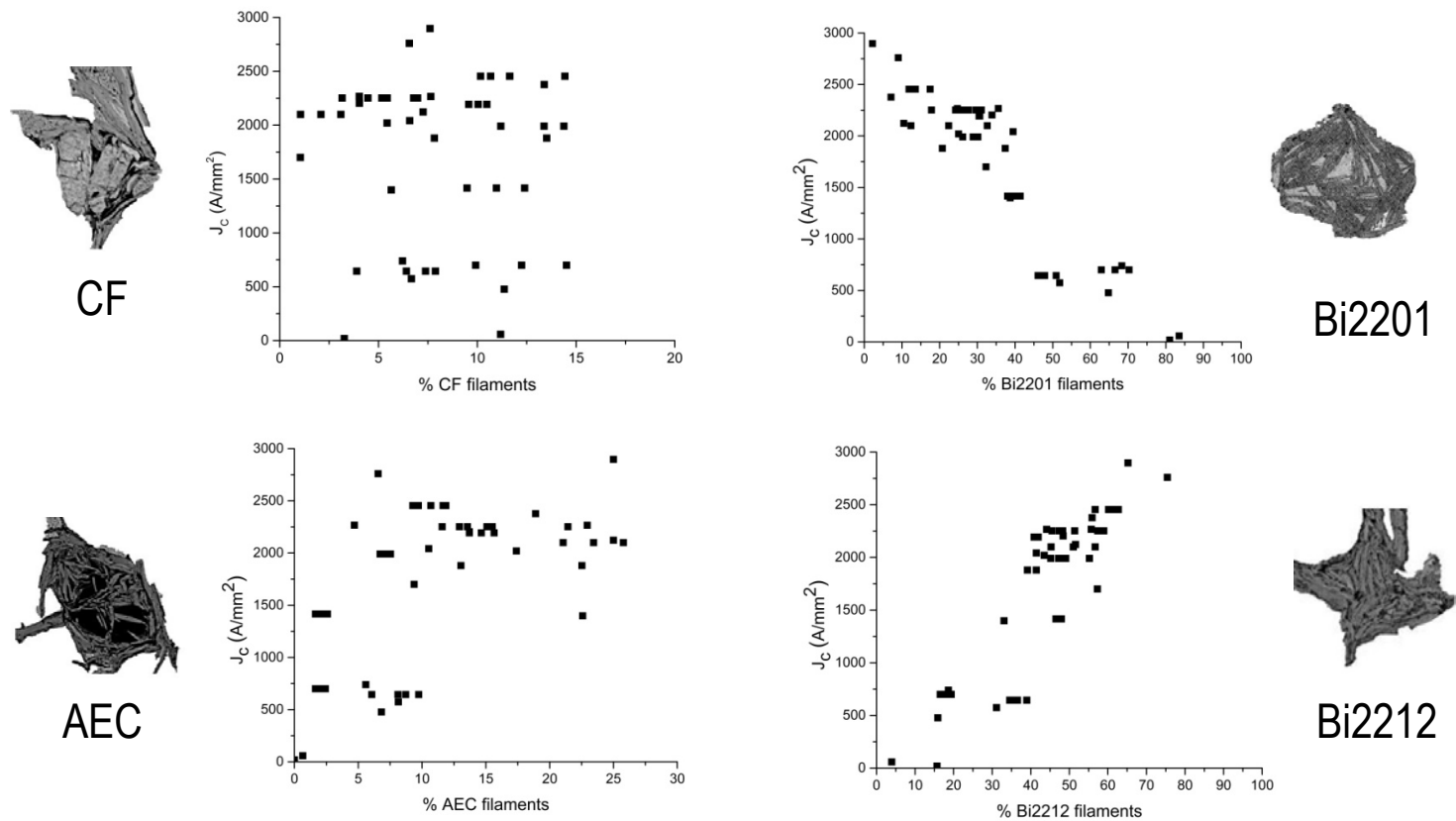
Statistical analysis of filament microstructure



- A Matlab program analyzes the SEM micrographs and categorizes over 100 filaments within the image
- A total of 41 cross-sections and 5506 filaments are characterized

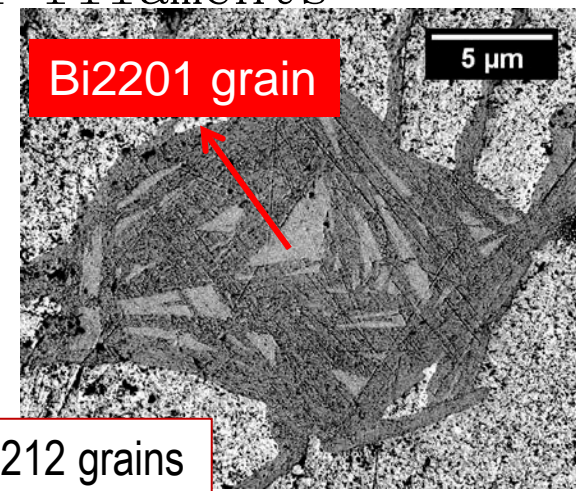
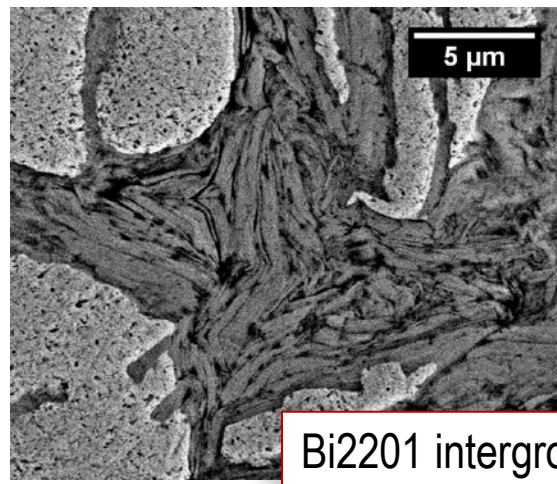


Statistical analysis of the relationship between electrical transport and filament microstructure in Bi2212

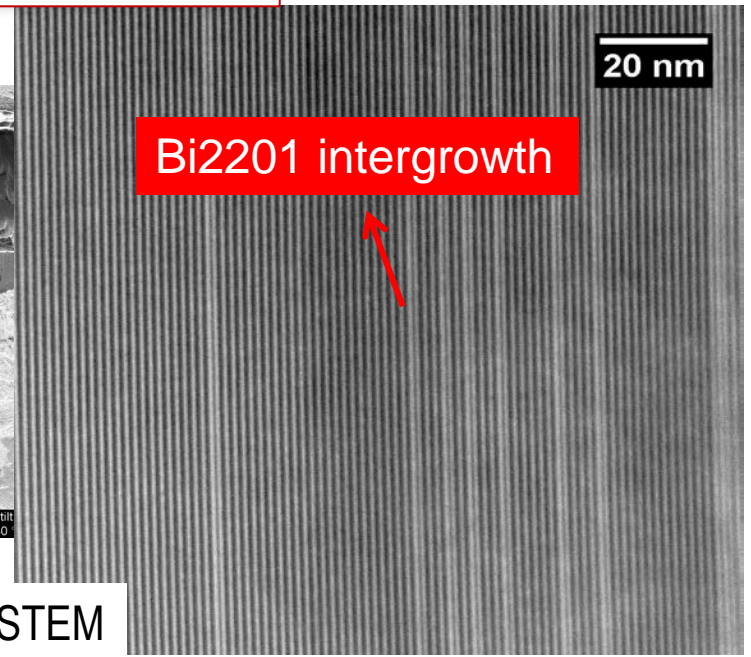
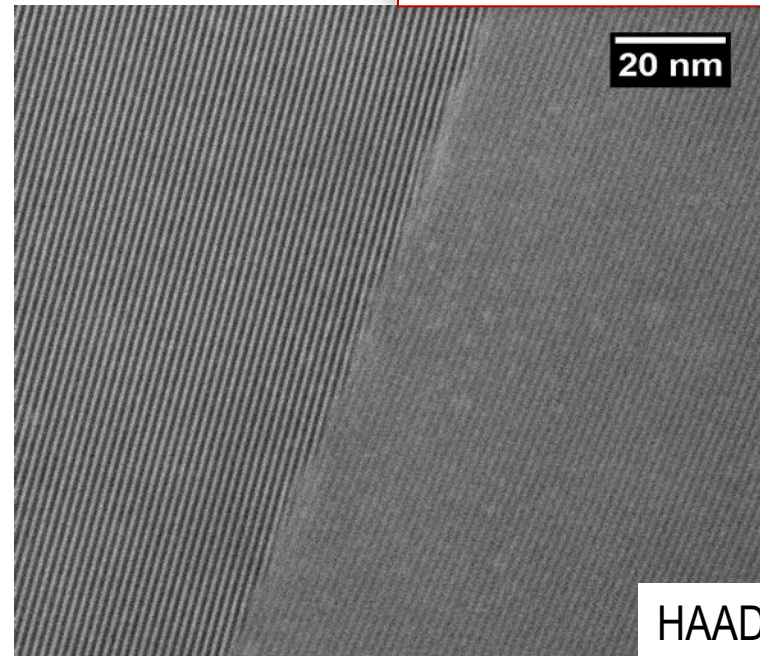


Conditions that avoid the formation of Bi2201 result in Bi2212 and AEC formation
 To improve J_c :
 Avoid the formation of Bi2201 grains and /or ensure conversion of Bi2201 to Bi2212

Bi2212 grains in individual filaments Bi2212 vs. Bi2201 filaments

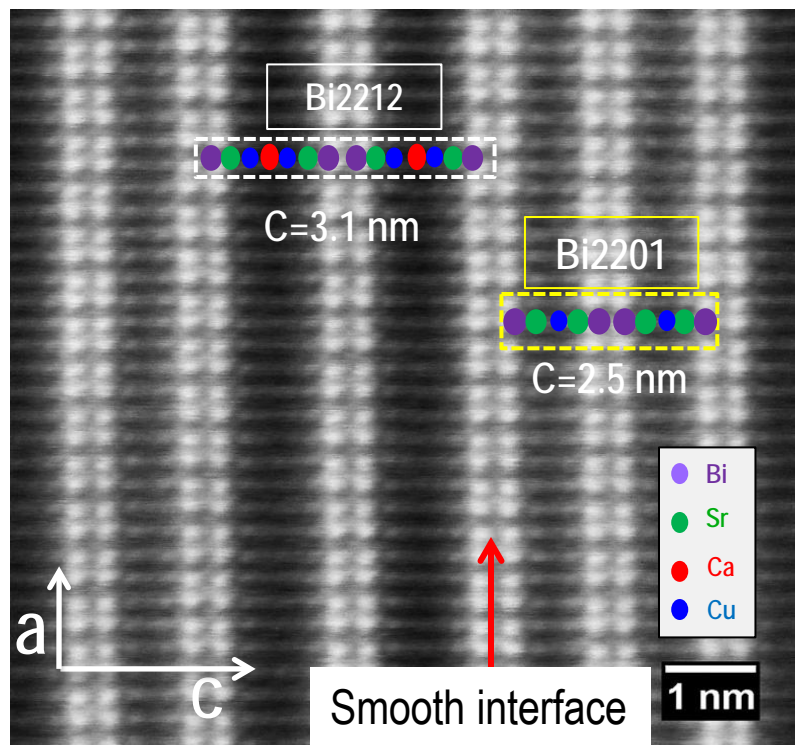
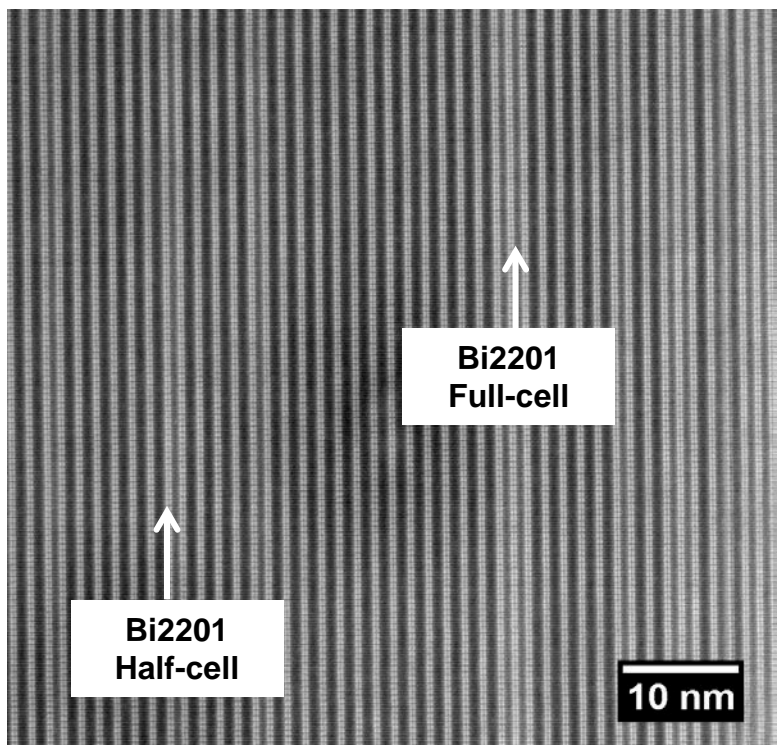


Bi2201 intergrowths in Bi2212 grains



HAADF STEM

Atomic resolution HAADF STEM Bi2212 / Bi2201 intergrowths

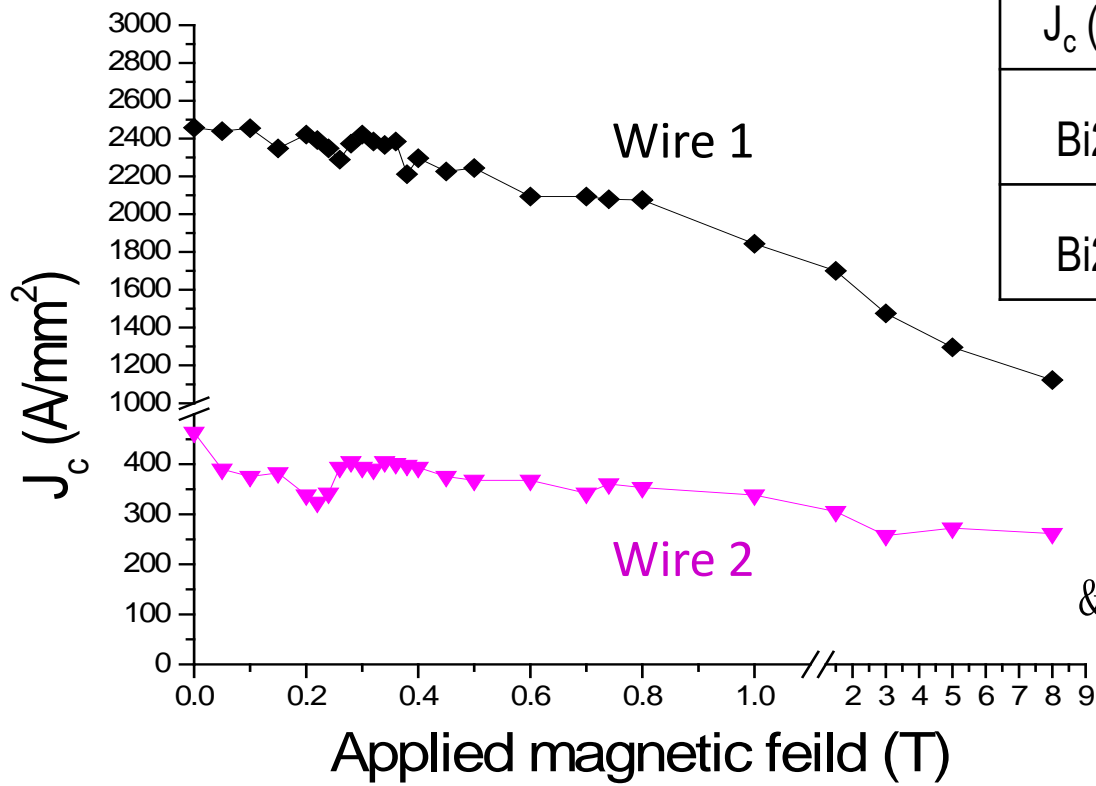


$\xi(4.2 K)$ ranges **3.09 nm – 3.07 nm**

ξ and Bi2201 half-cell and full-cell on the same order of magnitude

Intergrowths **Josephson Junctions & Pinning centers ??**

Transport magnetic field dependency to study the roles of Bi2201 intergrowths



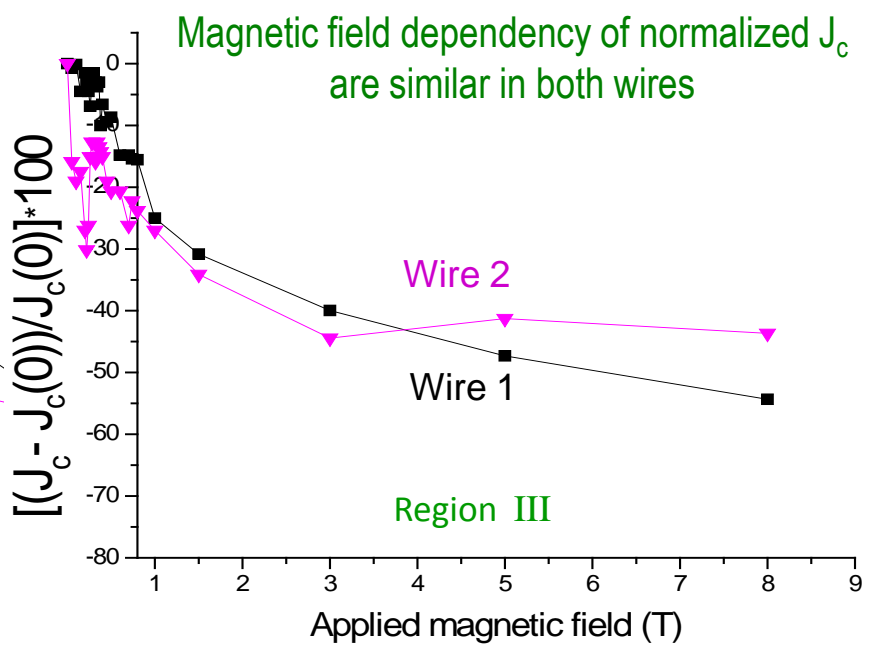
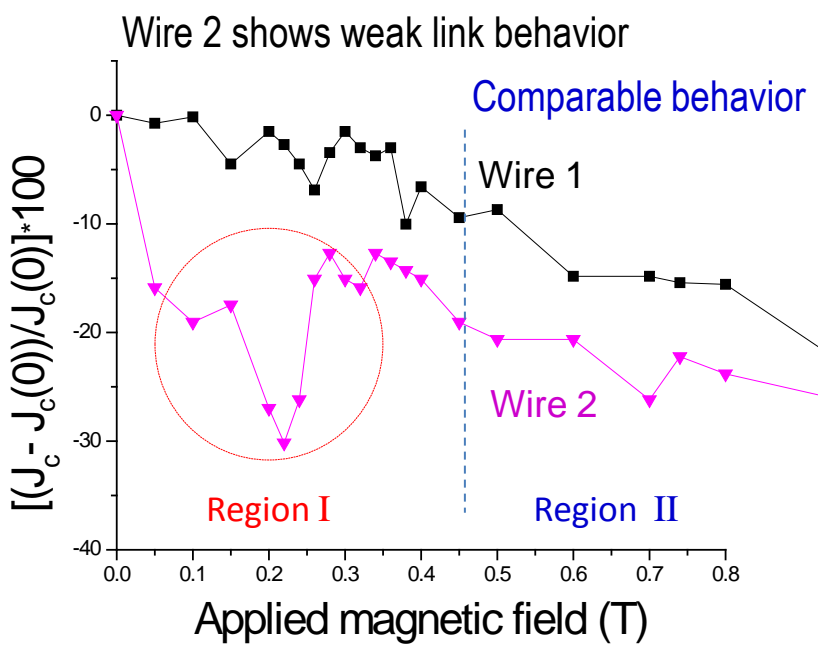
	Wire 1	Wire 2
J_c (sf, 4.2 K), A/mm ²	2450	460
Bi2212 filaments%	60	31
Bi2201 filaments%	14	52

To distinguish weak link, Josephson Junction (JJ) & magnetic flux pinning regions

Normalized transport as a function of magnetic field to deconvolute roles of Bi2201

Weak link & JJ

Flux pinning



Bi2212/Bi2201 grain interfaces are weak links

Bi2201 half-cell & full-cell intergrowths are JJs

Bi2201 half-cell & full-cell are pinning centers

Multiscale Bi2201 in dense Bi2212 wires Over-pressure partial melt processing (OP-PMP) at the NHMFL

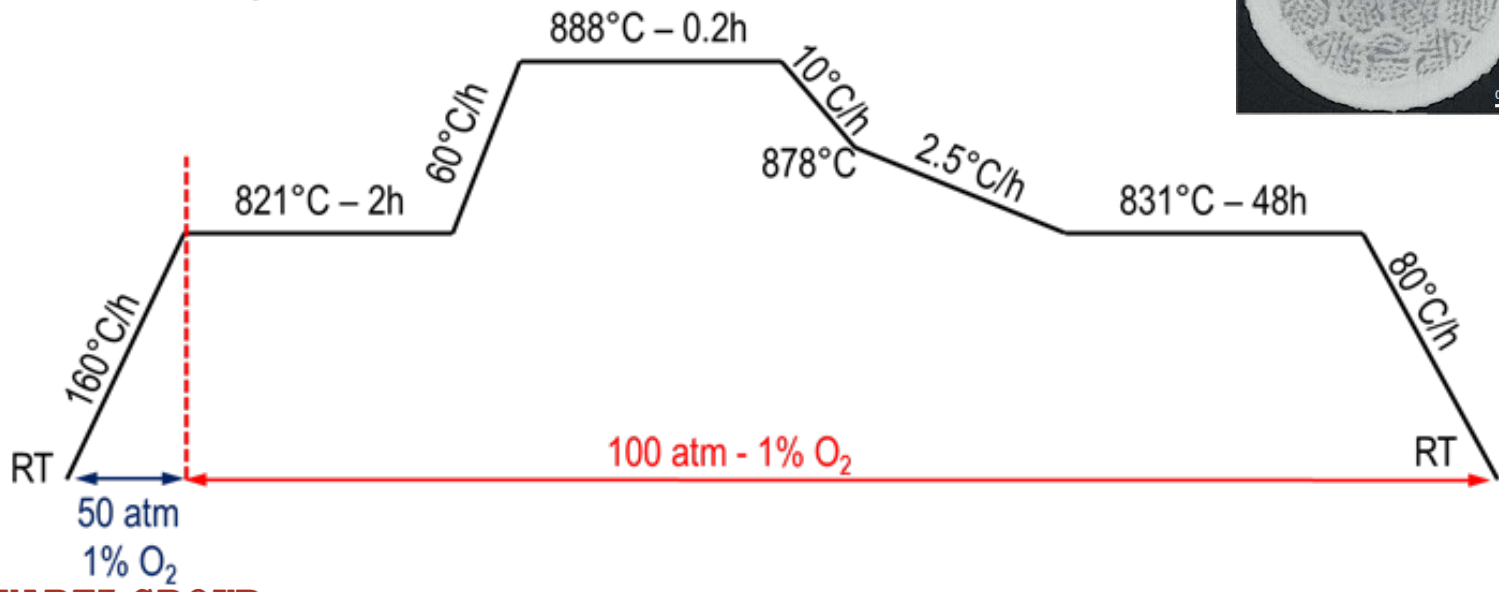
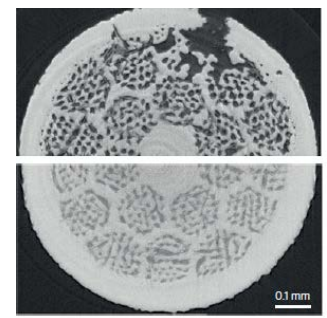
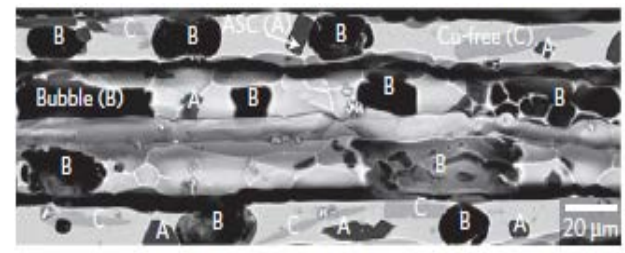
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PUBLISHED ONLINE: 9 MARCH 2014 | DOI: 10.1038/NMAT3887

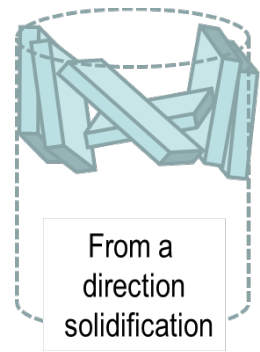
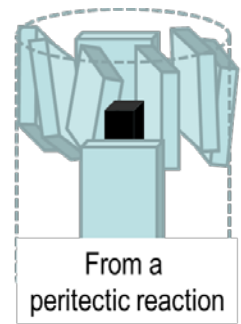
Isotropic round-wire multifilament cuprate superconductor for generation of magnetic fields above 30 T

D. C. Larbalestier^{1*}, J. Jiang¹, U. P. Trociewitz¹, F. Kametani¹, C. Scheuerlein², M. Dalban-Canassy¹, M. Matras¹, P. Chen¹, N. C. Craig¹, P. J. Lee¹ and E. E. Hellstrom¹

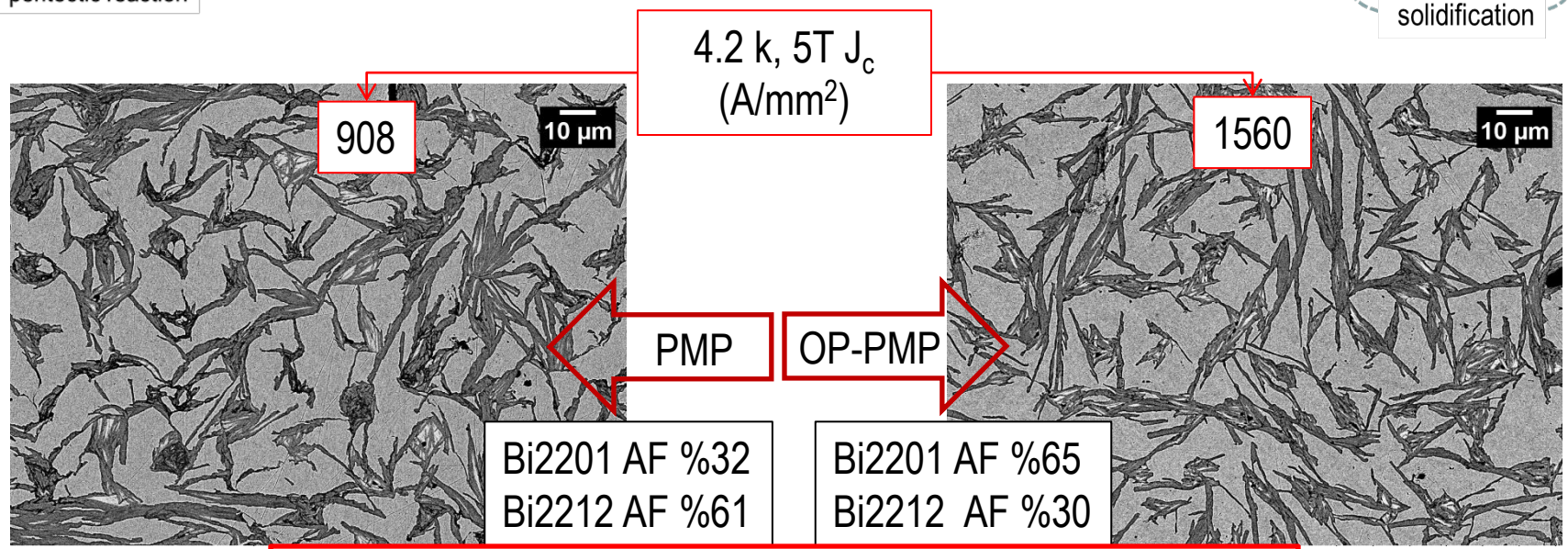


100 atm OP-PMP densifies filaments but produces more Bi2201 filaments

Grain growth in pre-annealing & 100 atm OP increases Bi2212 peritectic melting point

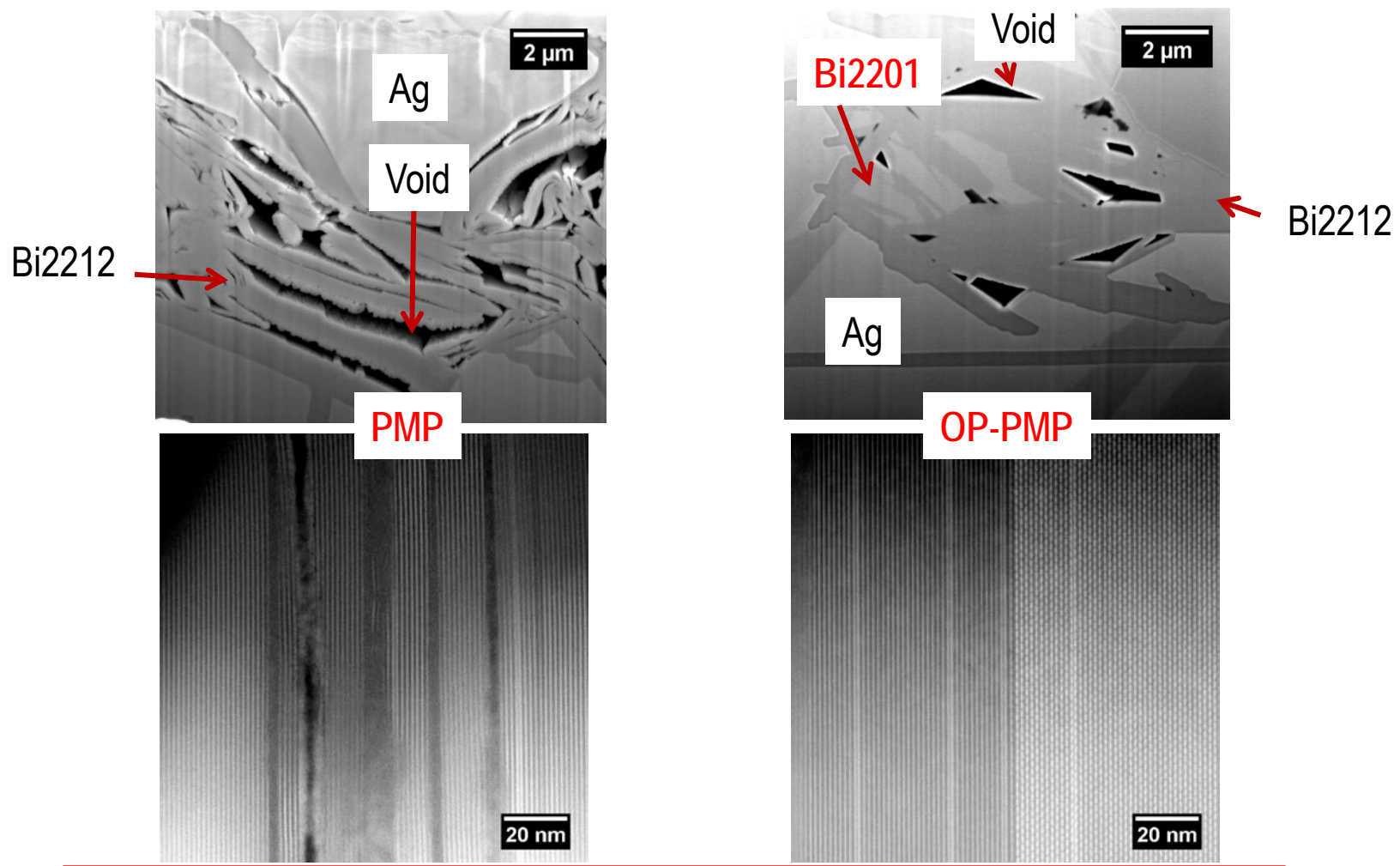


Low T_{max} relative to T_p results more Bi2201 filaments



With reducing Bi2201 filament content J_c will increase further

Multiscale OP-PMP densification



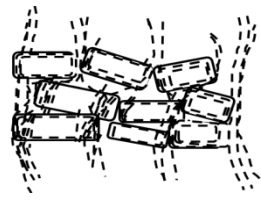
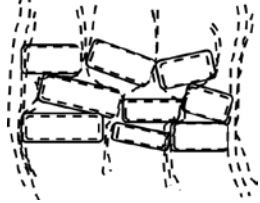
OP densifies both micron and nanoscale, improves intragrain connectivity
However forms more Bi2201 grains

Oxygen content, Intergrain and intragrain connectivity of PMP & OP-PMP

No significant difference in overall oxygen content

$$H_{C1}^w < H_a < H_{C1}^G$$

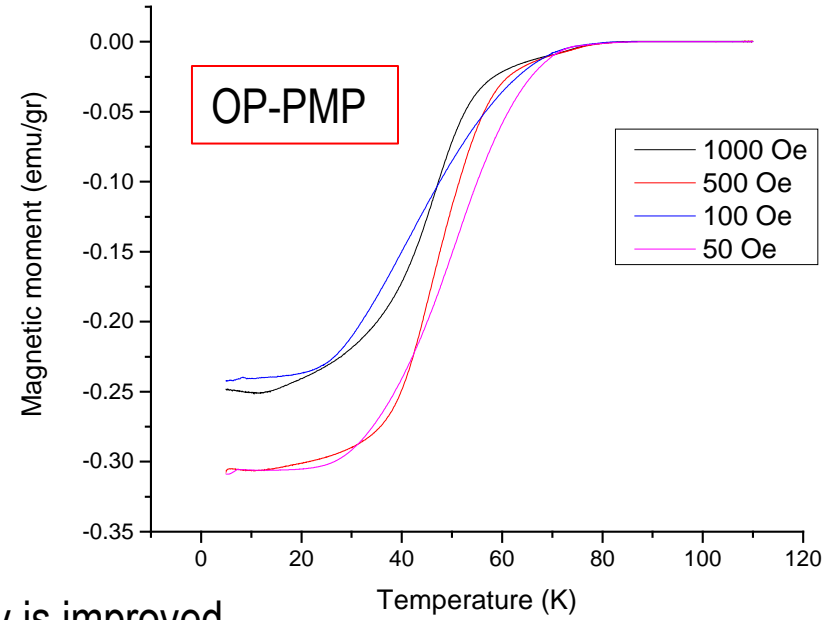
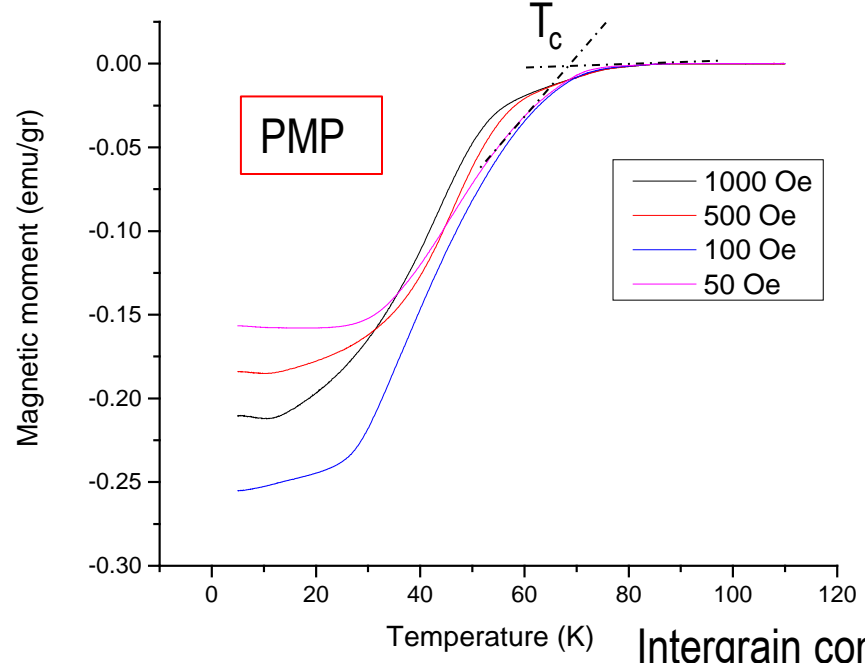
$$H_a > H_{C1}^G$$



At 50 Oe, intergrain dominates
 OP-PMP shows much stronger magnetic moment

Above H_{C1}^G the grain size and pinning mechanisms determine the magnetization

At 100 Oe (H_{C1}^G) both wires show the similar magnetic moment

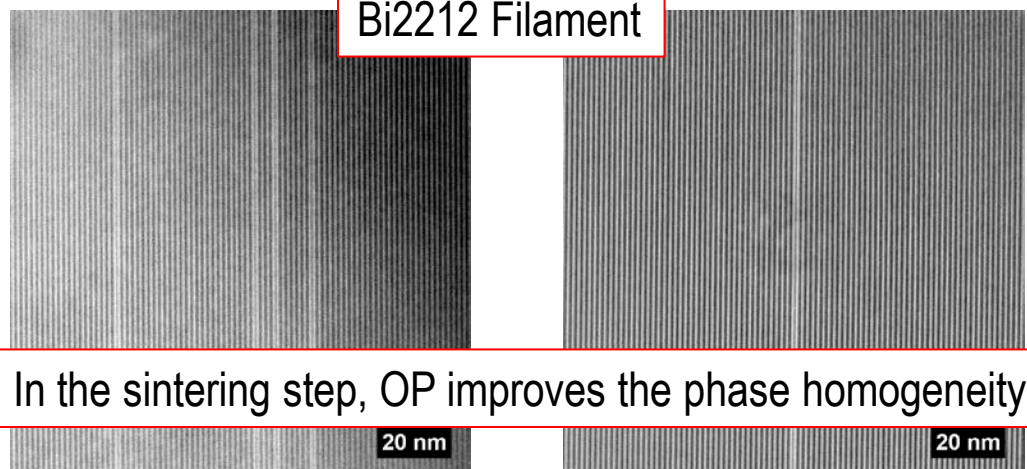


Intergrain connectivity is improved

No significant change in intragrain connectivity

To study the intragrain structures (HAADF-STEM) & semi-quantitative EDS

Bi2212 Filament



	at. %	Standard deviation
Bi	22.2	2.01
Sr	20.3	1.20
Ca	6	0.56
Cu	19.8	0.77
O	32.3	2.99

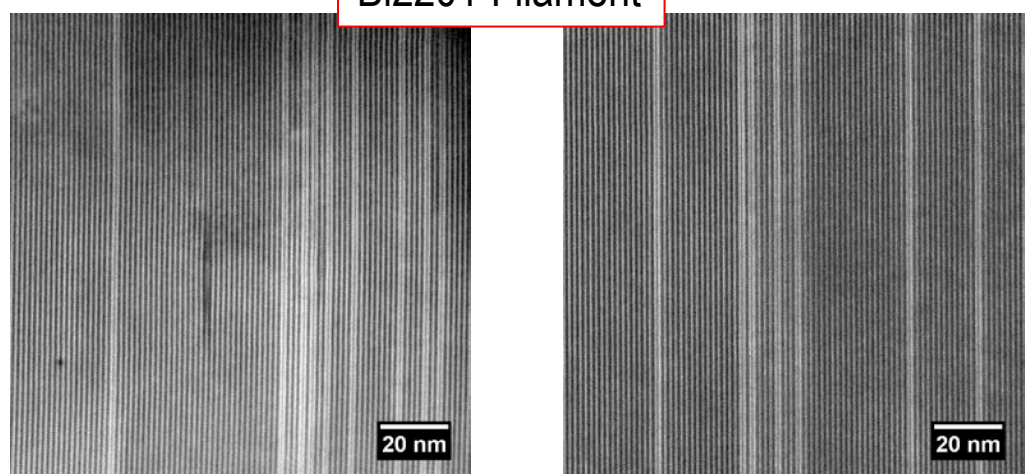
	at. %	Standard deviation
Bi	21.7	0.39
Sr	20.2	0.41
Ca	5.8	0.30
Cu	21.6	0.53
O	30.4	1.2

In the sintering step, OP improves the phase homogeneity

PMP

Bi2201 Filament

OP-PMP



	at. %	Standard deviation
Bi	19.9	0.95
Sr	17.8	0.79
Ca	6.3	0.45
Cu	19.7	1.25
<u>O</u>	<u>36.2</u>	<u>3.20</u>

	at. %	Standard deviation
Bi	18.0	0.48
Sr	16.0	0.70
Ca	6.8	0.29
Cu	18.7	0.55
<u>O</u>	<u>40.2</u>	<u>1.95</u>

Bi2201 filaments contain higher oxygen content than Bi2212 filaments

Conclusions

- The primary impurity in partial-melt processed in Bi2212 wires is Bi2201, which forms as mesoscopic grains and nanoscopic intergrowths.
- Future improvements in Bi2212 wires require the elimination of Bi2201 grains.
- Half- and full-cell Bi2201 intergrowths show Josephson-Junction-like behavior at low field and flux pinning at higher field, so they are beneficial and non-detrimental to transport.
- OP-PMP increases Bi2212 filament density, improves intergrain connectivity, and consequently enhances J_c ; however, with the present profile it also produces more Bi2201 grains.
- We predict that with elimination of Bi2201 filaments J_c will increase further in OP-PMP wires

Acknowledgments

- NCSU Analytical Instrumentation Facility (Dr. Xiahan Sang)
- Supercon, Inc.
- National High Magnetic Field Laboratory

Thank you!!

Questions,
comments ???

